Vishay Siliconix

P-Channel 20 V (D-S) MOSFET



Marking code: BQ

PRODUCT SUMMARY	
V _{DS} (V)	-20
$R_{DS(on)}$ max. (Ω) at V_{GS} = -4.5 V	0.0240
$R_{DS(on)}$ max. (Ω) at V_{GS} = -2.5 V	0.0321
$R_{DS(on)}$ max. (Ω) at $V_{GS} = -1.8 \text{ V}$	0.0511
Q _g typ. (nC)	19.8
I _D (A) ^{a, d}	-8
Configuration	Single

FEATURES

- TrenchFET® Gen III p-channel power MOSFET
- $R_{DS(on)}$ rating at $V_{GS} = -1.8 \text{ V}$
- 100 % R_q and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

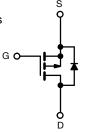


RoHS COMPLIANT

HALOGEN FREE

APPLICATIONS

- Battery management in mobile devices
- · Battery switch
- · Load switch
- PA switch



P-Channel MOSFET

ORDERING INFORMATION	
Package	TSOP-6
Lead (Pb)-free and halogen-free	Si3493DDV-T1-GE3

PARAMETER Drain-source voltage Gate-source voltage		SYMBOL	LIMIT	UNIT	
		V _{DS}	-20 ± 8		
		V _{GS}			
	T _C = 25 °C		-8 ^a		
Continuous dusis surrent (T. 150 °C)	T _C = 70 °C		-8		
Continuous drain current (T _J = 150 °C)	T _A = 25 °C	I _D	-7.5 ^{b, c}		
	T _A = 70 °C		-6 ^{b, c}	^	
Pulsed drain current (t = 100 μs)		I _{DM}	-32	Α	
	T _C = 25 °C		-3		
Continuous source-drain diode current	T _A = 25 °C	I _S	-1.67 ^{b, c}		
Single pulse avalanche current	1 04	I _{AS}	-10		
Single pulse avalanche energy	L = 0.1 mH	E _{AS}	5	mJ	
	T _C = 25 °C		3.6		
Maximum power dissipation	T _C = 70 °C		2.3	W	
	T _A = 25 °C	P _D	2 b, c		
	T _A = 70 °C		1.3 ^{b, c}		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C	

THERMAL RESISTANCE RATINGS							
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT		
Maximum junction-to-ambient ^b	t ≤ 5 s	R _{thJA}	50	62.5	°C/W		
Maximum junction-to-case (drain)	Steady state	R _{thJC}	28	35	C/VV		

- a. Package limited.
- Surface mounted on 1" x 1" FR4 board.
- c. t = 5 s. d. Maximum under steady state conditions is 110 °C/W.

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.		MAX.	UNIT	
Static							
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-20	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	J 050 A	-	-12	-	mV/°C	
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = -250 μA	-	2.5	-		
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	-0.4	-	-1	V	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$	-	-	± 100	nA	
Zava cata valtaca dvain augusat		V _{DS} = -20 V, V _{GS} = 0 V	-	-	-1	μΑ	
Zero gate voltage drain current	I _{DSS}	V _{DS} = -20 V, V _{GS} = 0 V, T _J = 70 °C	-	-	-10		
On-state drain current ^a	I _{D(on)}	$V_{DS} \ge -10 \text{ V}, V_{GS} = -4.5 \text{ V}$	-20	-	-	Α	
		$V_{GS} = -4.5 \text{ V}, I_D = -7.5 \text{ A}$	-	0.0200	0.0240)	
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = -2.5 \text{ V}, I_D = -6.4 \text{ A}$	-	0.0257	0.0321	Ω	
	, ,	V _{GS} = -1.8 V, I _D = -2 A	-	0.0378	0.0511		
Forward transconductance a	9fs	$V_{DS} = -10 \text{ V}, I_D = -7.5 \text{ A}$	-	30	-	S	
Dynamic ^b							
Input capacitance	C _{iss}		-	1825	-	pF	
Output capacitance	C _{oss}	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	210	-		
Reverse transfer capacitance	C _{rss}		-	200	-		
Total gate charge	Qg	$V_{DS} = -10 \text{ V}, V_{GS} = -8 \text{ V}, I_{D} = -7.5 \text{ A}$	-	34.8	52.2	nC	
			-	19.8	30		
Gate-source charge	Q _{gs}	$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -7.5 \text{ A}$	-	2.6	-		
Gate-drain charge	Q_{gd}		-	3	-		
Gate resistance	Rq	f = 1 MHz	2.12	10.6	21.2	Ω	
Turn-on delay time	t _{d(on)}		-	25	38		
Rise time	t _r	$V_{DD} = -10 \text{ V}, R_L = 1.67 \Omega, I_D \cong -6 \text{ A},$	-	30	45	1	
Turn-off delay time	t _{d(off)}	$V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$	-	95	145	1	
Fall time	t _f		-	40	60	1	
Turn-on delay time	t _{d(on)}		-	8	16	ns	
Rise time	t _r	$V_{DD} = -10 \text{ V}, R_1 = 1.67 \Omega, I_D \cong -6 \text{ A},$	_	20	30		
Turn-off delay time	t _{d(off)}	$V_{GEN} = -8 \text{ V}, R_g = 1 \Omega$	-	115	173		
Fall time	t _f		-	40	60	1	
Drain-Source Body Diode Characteristi	cs			1			
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	-8		
Pulse diode forward current	I _{SM}	-	-	-	-32	A	
Body diode voltage	V _{SD}	I _S = -6 A, V _{GS} = 0 V	-	-0.8	-1.2	V	
Body diode reverse recovery time	t _{rr}		-	21	32	ns	
Body diode reverse recovery charge	Q _{rr}		-	9	18	nC	
Reverse recovery fall time	ta	$I_F = -6 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 °\text{C}$	-	9	-	1	
Reverse recovery rise time	t _b			12	_	ns	

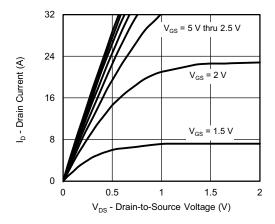
Notes

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

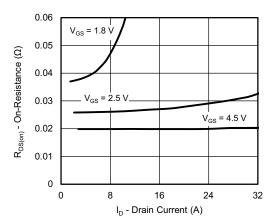
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



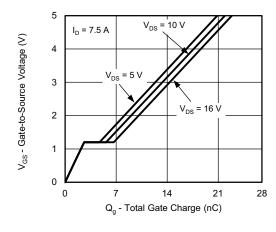
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



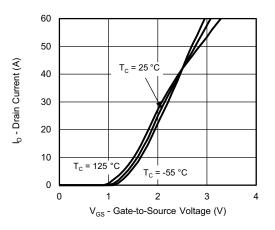
Output Characteristics



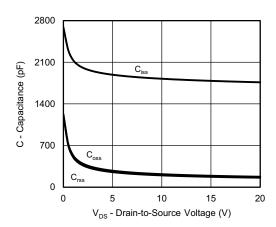
On-Resistance vs. Drain Current and Gate Voltage



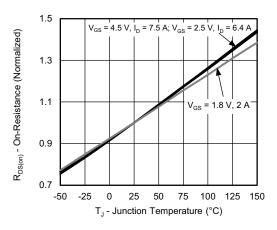
Gate Charge



Transfer Characteristics



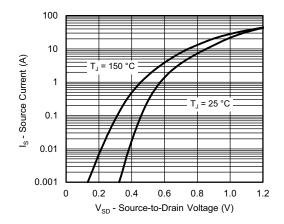
Capacitance



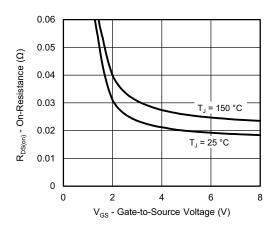
On-Resistance vs. Junction Temperature



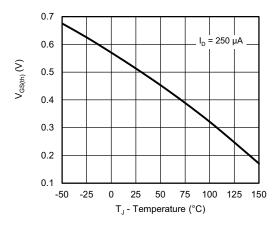
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



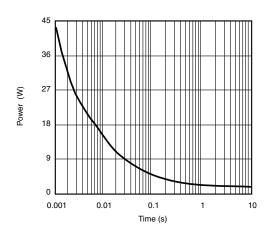
Source-Drain Diode Forward Voltage



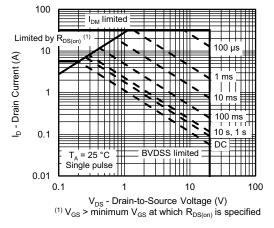
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



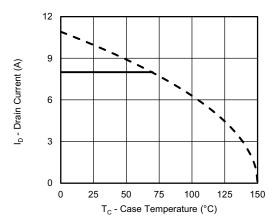
Single Pulse Power, Junction-to-Ambient



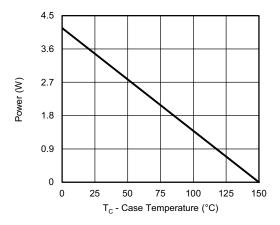
Safe Operating Area, Junction-to-Ambient

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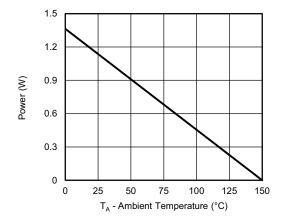
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating a







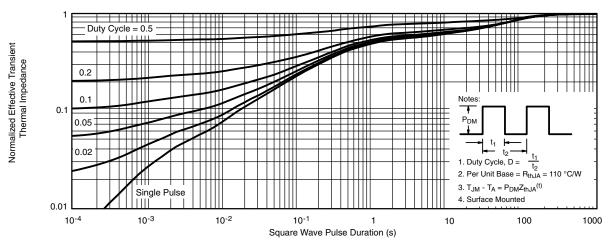
Power, Junction-to-Ambient

Note

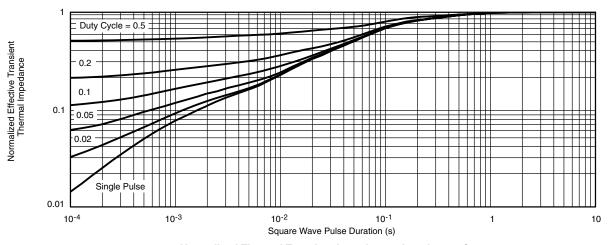
a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

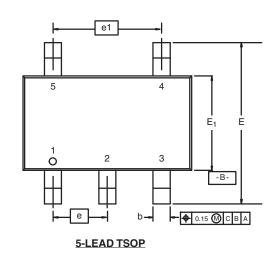
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?74735.

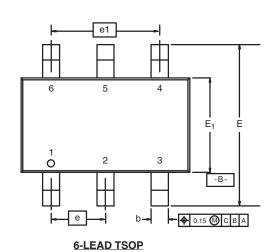


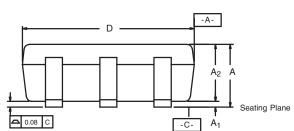


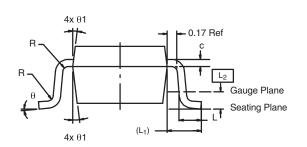
TSOP: 5/6-LEAD

JEDEC Part Number: MO-193C









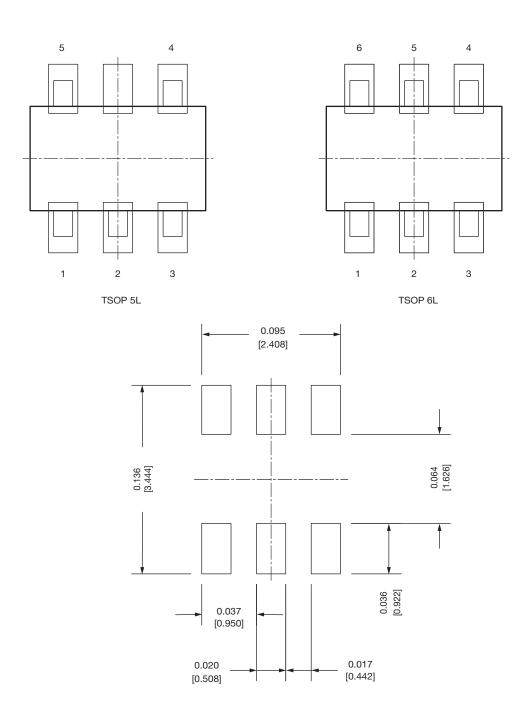
	MILLIMETERS			INCHES			
Dim	Min	Nom	Max	Min	Nom	Max	
Α	0.91	-	1.10	0.036	-	0.043	
A ₁	0.01	-	0.10	0.0004	-	0.004	
A ₂	0.90	-	1.00	0.035	0.038	0.039	
b	0.30	0.32	0.45	0.012	0.013	0.018	
С	0.10	0.15	0.20	0.004	0.006	0.008	
D	2.95	3.05	3.10	0.116	0.120	0.122	
E	2.70	2.85	2.98	0.106	0.112	0.117	
E ₁	1.55	1.65	1.70	0.061	0.065	0.067	
е		0.95 BSC		0.0374 BSC			
e ₁	1.80	1.90	2.00	0.071	0.075	0.079	
L	0.32	-	0.50	0.012	-	0.020	
L ₁	0.60 Ref			0.024 Ref			
L ₂	0.25 BSC			0.010 BSC			
R	0.10	-	-	0.004	-	-	
θ	0°	4°	8°	0°	4°	8°	
θ_1	7° Nom			7° Nom			
ECN: C-06593-Rev. I, 18-Dec-06 DWG: 5540							

Document Number: 71200

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Recommended Land Pattern For TSOP-5L / TSOP-6L



Note

• All dimensions are in inches (millimeter)

ECN: C22-0860-Rev. B, 24-Oct-2022 DWG: 3010



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